Appln. No. 09/883,438

Amdt. dated October 21, 2005

Reply to Office Action dated July 21, 2005

IN THE ABSTRACT OF THE DISCLOSURE:

Please amend the Abstract of the Disclosure as follows:

The invention relates to an An integrated circuit comprising

including a substrate, a conductive layer [[(1)]], at least one

inductive element [[(2)]] superposed on said the conductive layer

and formed by a metallic turn having an outer contour and an

inner contour, which bound between them a surface referred to as

the radiation surface, and means insulating material for

insulating the conductive layer from the inductive element. The

conductive layer has a surface substantially identical to the

radiation surface.

The invention makes it possible to integrate other elements

in a circuit as described above, without a resulting increase in

the size of said circuit and without the operation of said other

elements being disturbed by the inductive element.

Use: Particularly voltage-controlled oscillators.

Reference: Fig. 1.

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